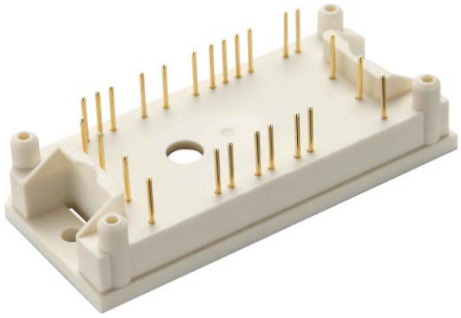
STARPOWER

SEMICONDUCTOR **IGBT**

GD10PIK120F5S

Molding Type Module

1200V/10A PIM in one-package



General Description

STARPOWER IGBT Power Module provides ultra low conduction and switching loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.

Features

- Low $V_{CE(sat)}$ NPT IGBT technology
- 10μs short circuit capability
- Square RBSOA
- $V_{CE(sat)}$ with positive temperature coefficient
- Fast & soft reverse recovery anti-parallel FWD

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

IGBT-inverter T_C=25℃ unless otherwise noted

Maximum Rated Values

Symbol	Description	GD10PIK120F5S	Units
V_{CES}	Collector-Emitter Voltage @ T_j=25℃	1200	V
V_{GES}	Gate-Emitter Voltage @ T_j=25℃	±20	V
I_C	Collector Current @ T_C=25℃ @ T_C=80℃	20 10	A
I_{CM}	Pulsed Collector Current t_p=1ms	20	A
P_{tot}	Total Power Dissipation @ T_j=150℃	103	W

Off Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	T_j=25℃	1200			V
I_{CES}	Collector Cut-Off Current	V_{CE}=V_{CES},V_{GE}=0V, T_j=25℃			1.0	mA
I_{GES}	Gate-Emitter Leakage Current	V_{GE}=V_{GES},V_{CE}=0V, T_j=25℃			400	nA

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	I_C=125μA,V_{CE}=V_{GE}, T_j=25℃	4.4	5.0	6.0	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	I_C=10A,V_{GE}=15V, T_j=25℃		2.45	2.90	V
		I_C=10A,V_{GE}=15V, T_j=125℃		2.75		

Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$t_{d(on)}$	Turn-On Delay Time	V_{CC}=600V,I_C=10A, R_G=100Ω,V_{GE}=±15V, T_j=25℃		172		ns
t_r	Rise Time			55		ns
$t_{d(off)}$	Turn-Off Delay Time			189		ns
t_f	Fall Time			312		ns
E_{on}	Turn-On Switching Loss			2.34		mJ
E_{off}	Turn-Off Switching Loss			0.74		mJ
$t_{d(on)}$	Turn-On Delay Time	V_{CC}=600V,I_C=10A, R_G=100Ω,V_{GE}=±15V, T_j=125℃		176		ns
t_r	Rise Time			58		ns
$t_{d(off)}$	Turn-Off Delay Time			199		ns
t_f	Fall Time			443		ns
E_{on}	Turn-On Switching Loss			2.71		mJ
E_{off}	Turn-Off Switching Loss			0.98		mJ
C_{ies}	Input Capacitance	V_{CE}=30V,f=1Mhz, V_{GE}=0V		795		pF
C_{res}	Reverse Transfer Capacitance			25		pF
Q_G	Gate Charge	V_{CC}=600V,I_C=10A, V_{GE}=15V		48		nC
R_{Gint}	Internal Gate Resister			/		Ω
I_{SC}	SC Data	t_P≤10μs,V_{GE}=15V, T_j=125℃,V_{CC}=900V, V_{CEM}≤1200V		72		A

Diode-inverter T_C=25℃ unless otherwise noted

Maximum Rated Values

Symbol	Description	GD10PIK120F5S	Units
V_{RRM}	Repetitive Peak Reverse Voltage @ T_j=25℃	1200	V
I_F	DC Forward Current	10	A
I_{FRM}	Repetitive Peak Forward Current t_p=1ms	20	A

Characteristics Values

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Units
V_F	Diode Forward Voltage	I_F=10A,V_{GE}=0V	T_j=25℃		1.85	2.30	V
			T_j=125℃		2.05		
Q_r	Recovered Charge	I_F=10A, V_R=600V, R_G=100Ω, V_{GE}=-15V	T_j=25℃		0.98		μC
			T_j=125℃		1.51		
I_{RM}	Peak Reverse Recovery Current		T_j=25℃		6.6		A
			T_j=125℃		8.0		
E_{rec}	Reverse Recovery Energy		T_j=25℃		0.36		mJ
			T_j=125℃		0.53		

Diode-rectifier T_C=25℃ unless otherwise noted

Maximum Rated Values

Symbol	Description	GD10PIK120F5S	Units
V_{RRM}	Repetitive Peak Reverse Voltage @ T_j=25℃	1600	V
$I_{F(AV)}$	Average On-state Current @ T_C=100℃	31	A
I_{RMSM}	Maximum RMS Current At Rectifier Output @ T_C=80℃	60	A
I_{FSM}	Surge Forward Current V_R=0V,t_p=10ms,T_j=45℃	320	A
I^2t	I^2t-value,V_R=0V,t_p=10ms,T_j=45℃	510	A^2s

Characteristics Values

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Units
V_F	Diode Forward Voltage	I_F=30A	T_j=150℃		1.07		V
I_R	Reverse Current	T_j=150℃,V_R=1600V				2.0	mA

IGBT-brake-chopper T_C=25℃ unless otherwise noted

Maximum Rated Values

Symbol	Description	GD10PIK120F5S	Units
V_{CES}	Collector-Emitter Voltage @ T_j=25℃	1200	V
V_{GES}	Gate-Emitter Voltage @ T_j=25℃	±20	V
I_C	Collector Current @ T_C=25℃ @ T_C=80℃	20 10	A
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P_{tot}	Total Power Dissipation @ T_j=150℃	103	W

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$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	T_j=25℃	1200			V
I_{CES}	Collector Cut-Off Current	V_{CE}=V_{CES},V_{GE}=0V, T_j=25℃			1.0	mA
I_{GES}	Gate-Emitter Leakage Current	V_{GE}=V_{GES},V_{CE}=0V, T_j=25℃			400	nA

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	I_C=125μA,V_{CE}=V_{GE}, T_j=25℃	4.4	5.0	6.0	V
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		I_C=10A,V_{GE}=15V, T_j=125℃		2.75		

Switching Characteristics

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$t_{d(on)}$	Turn-On Delay Time	V_{CC}=600V,I_C=10A, R_G=100Ω,V_{GE}=±15V, T_j=25℃		172		ns
t_r	Rise Time			55		ns
$t_{d(off)}$	Turn-Off Delay Time			189		ns
t_f	Fall Time			312		ns
E_{on}	Turn-On Switching Loss			2.34		mJ
E_{off}	Turn-Off Switching Loss			0.74		mJ
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Diode-brake-chopper T_C=25℃ unless otherwise noted

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Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Units
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			T_j=125℃		2.05		
Q_r	Recovered Charge	I_F=10A, V_R=600V, R_G=100Ω, V_{GE}=-15V	T_j=25℃		0.98		μC
			T_j=125℃		1.51		
I_{RM}	Peak Reverse Recovery Current		T_j=25℃		6.6		A
			T_j=125℃		8.0		
E_{rec}	Reverse Recovery Energy		T_j=25℃		0.36		mJ
			T_j=125℃		0.53		

NTC T_C=25℃ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
R_{25}	Rated Resistance			4.7		kΩ
ΔR/R	Deviation of R_{100}	T_C=100℃,R_{100}=440.4Ω	-5		5	%
P_{25}	Power Dissipation				200	mW
$B_{25/50}$	B-value	$R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298.15K))]$		3512		K

IGBT Module

Symbol	Parameter	Min.	Typ.	Max.	Units
V_{ISO}	Isolation Voltage RMS,f=50Hz,t=1min	4000			V
$R_{\theta JC}$	Junction-to-Case (per IGBT-inverter) Junction-to-Case (per Diode-inverter) Junction-to-Case (per Diode-rectifier) Junction-to-Case (per IGBT-brake-chopper) Junction-to-Case (per Diode-brake-chopper)			1.219 1.827 1.193 1.218 1.844	K/W
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)		0.030		K/W
T_{jmax}	Maximum Junction Temperature			150	℃
T_{jop}	Operating Junction Temperature	-40		125	℃
T_{STG}	Storage Temperature Range	-40		125	℃

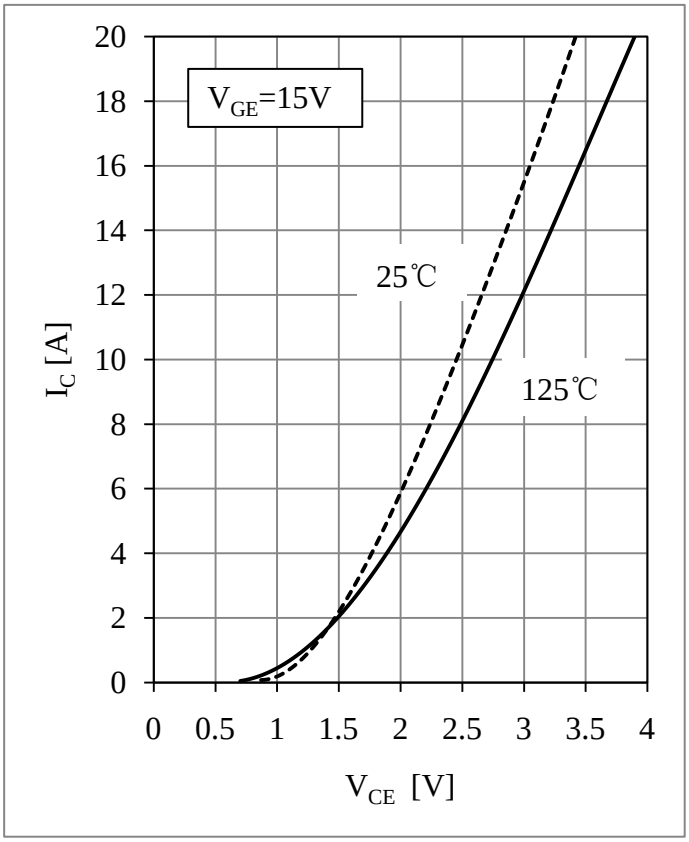


Fig 1. IGBT-inverter Output Characteristics

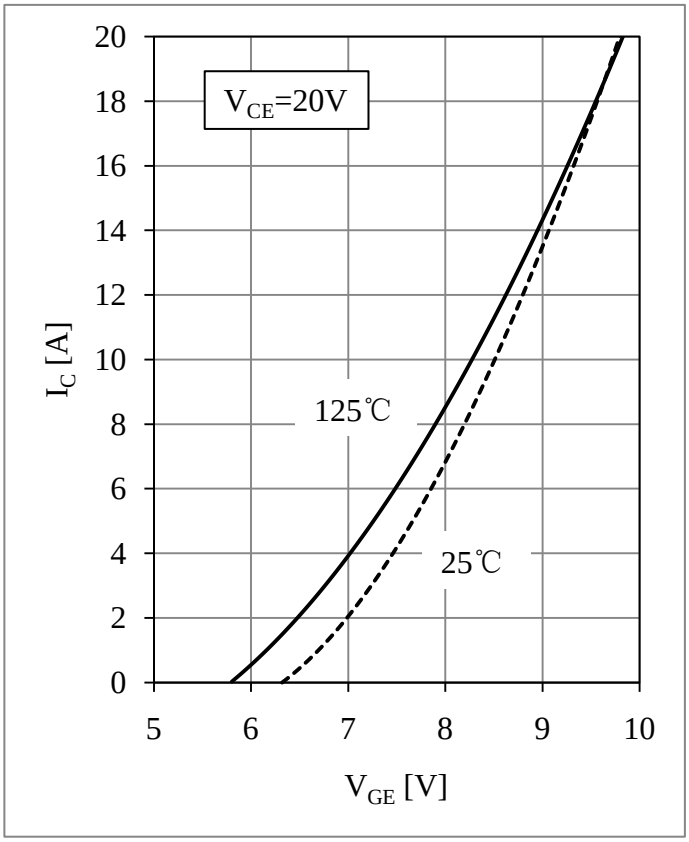


Fig 2. IGBT-inverter Transfer Characteristics

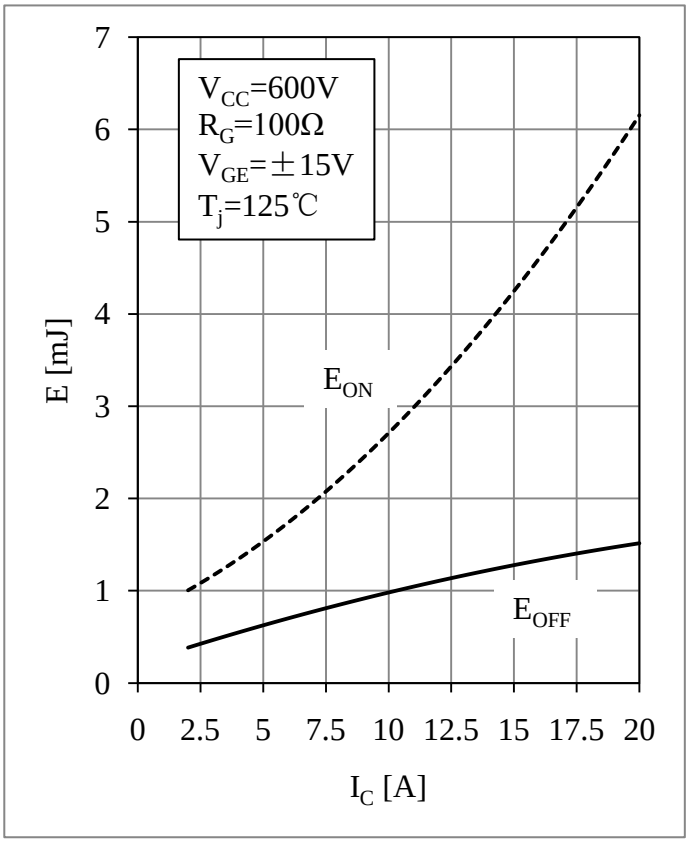


Fig 3. IGBT-inverter Switching Loss vs. I_C

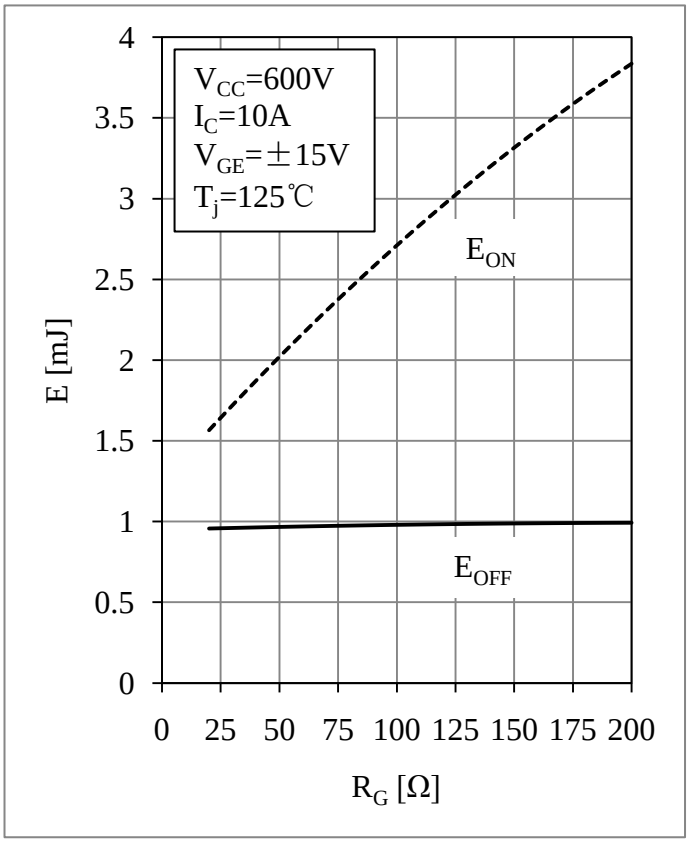


Fig 4. IGBT-inverter Switching Loss vs. R_G

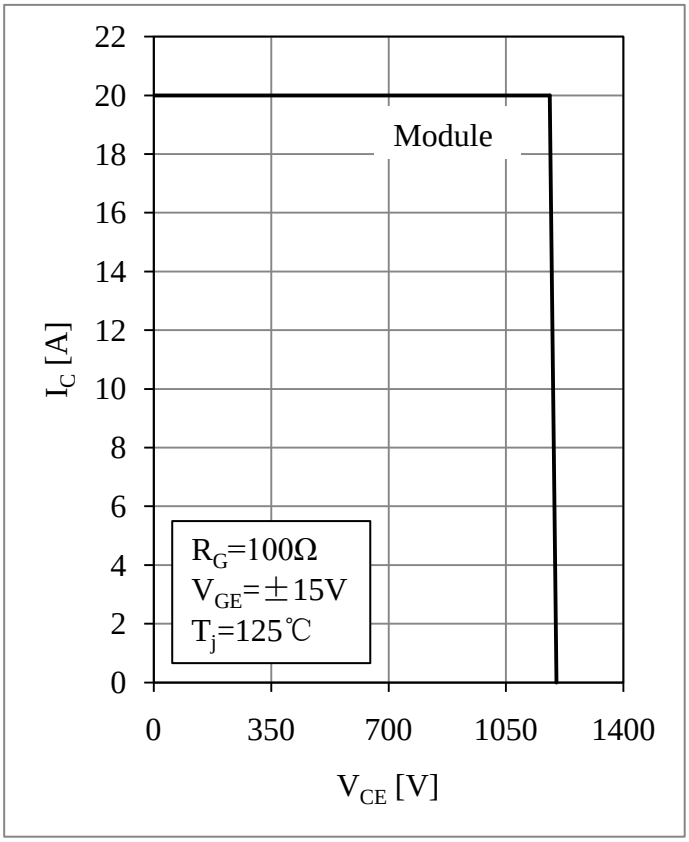


Fig 5. IGBT-inverter RBSOA

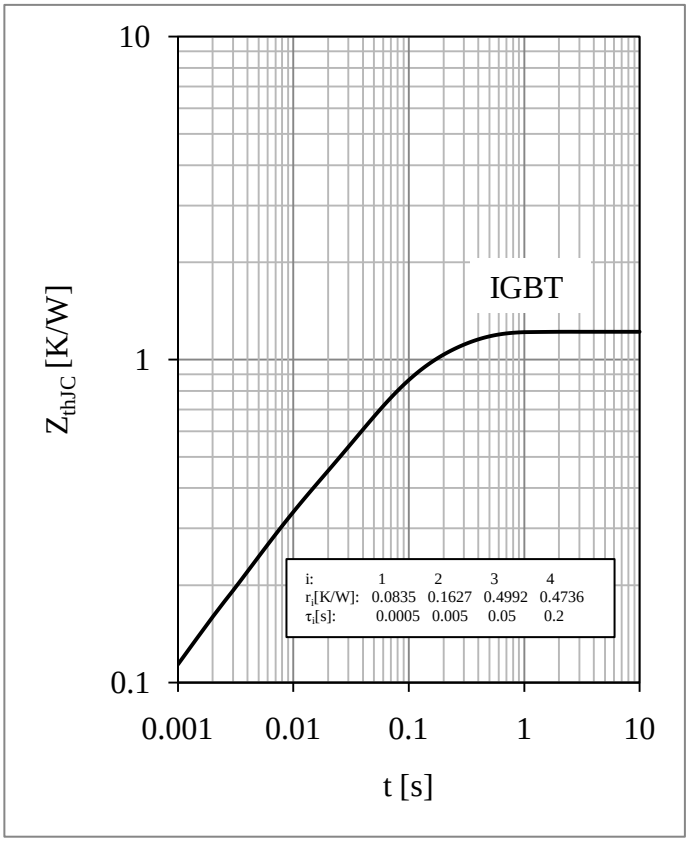


Fig 6. IGBT-inverter Transient Thermal Impedance

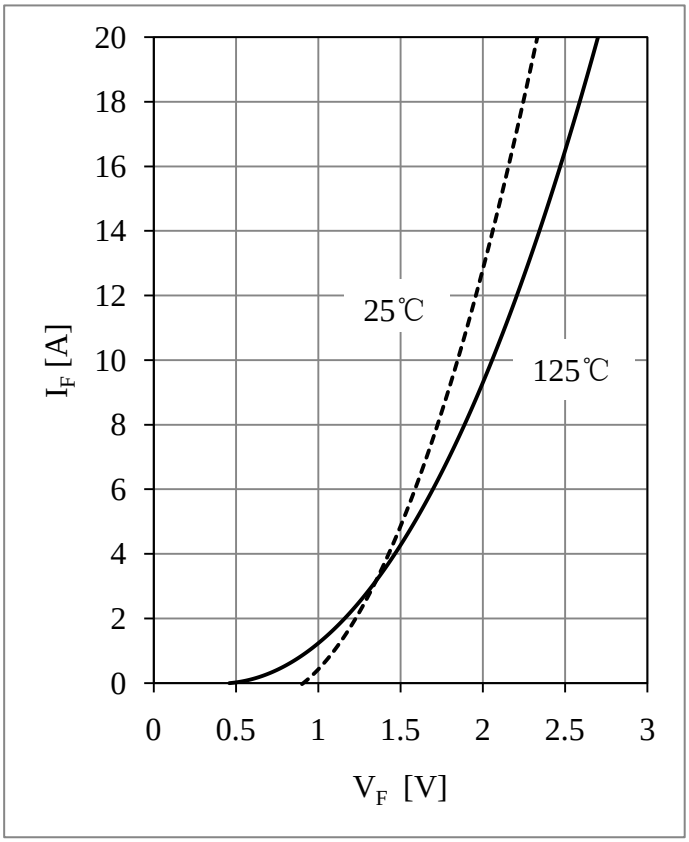


Fig 7. Diode-inverter Forward Characteristics

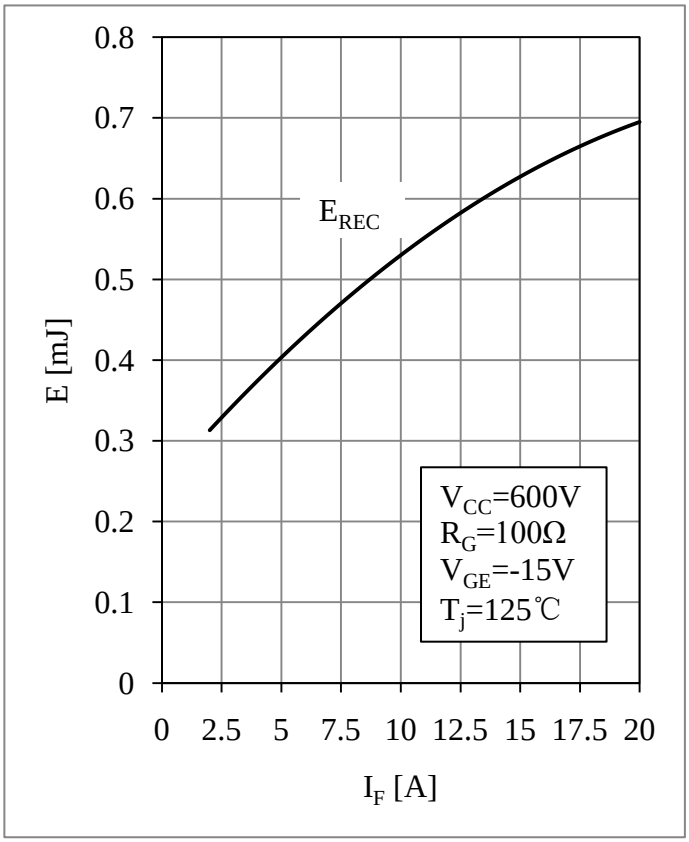


Fig 8. Diode-inverter Switching Loss vs. I_F

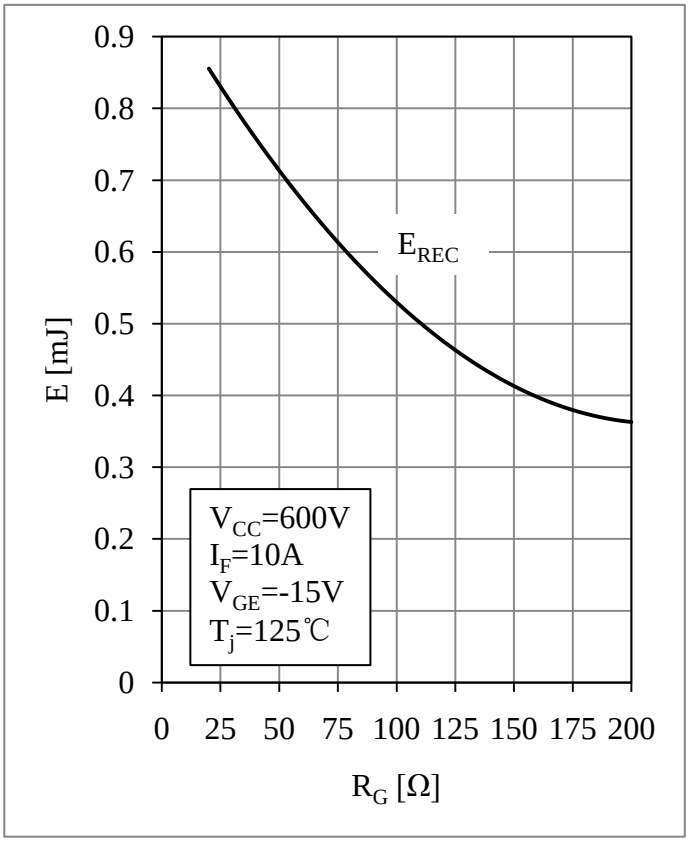


Fig 9. Diode-inverter Switching Loss vs. R_G

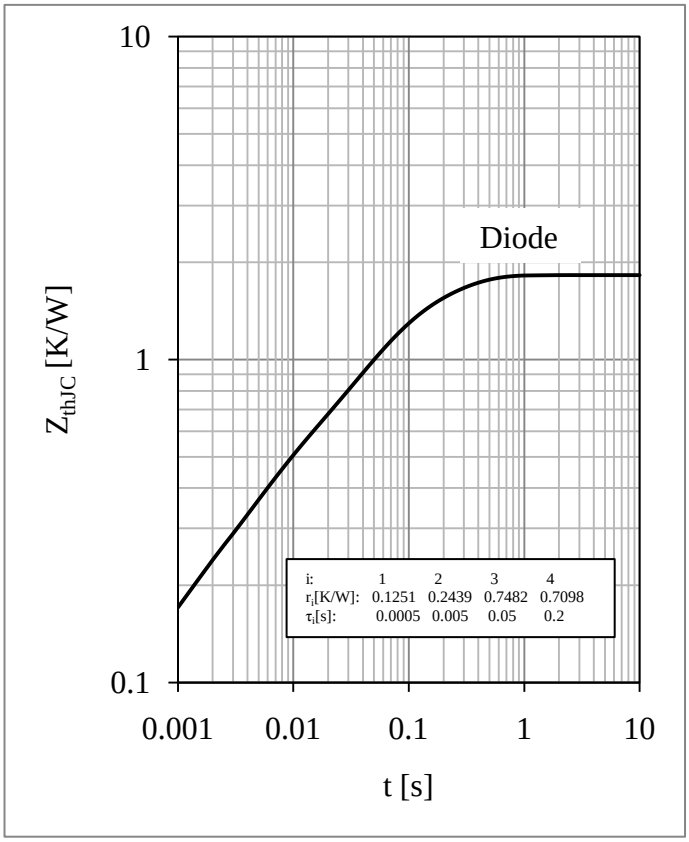


Fig 10. Diode-inverter Transient Thermal Impedance

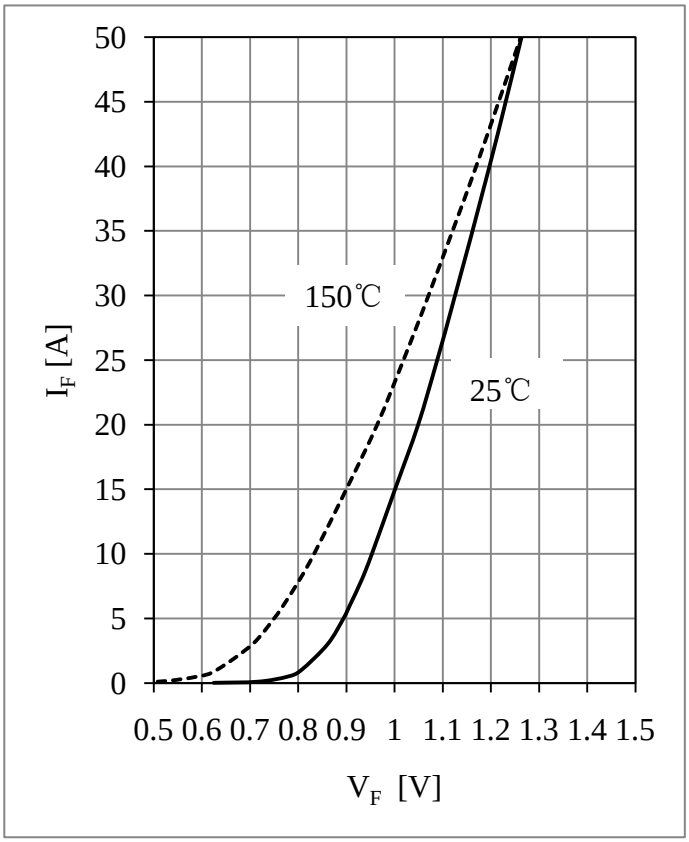


Fig 11. Diode-rectifier Forward Characteristics

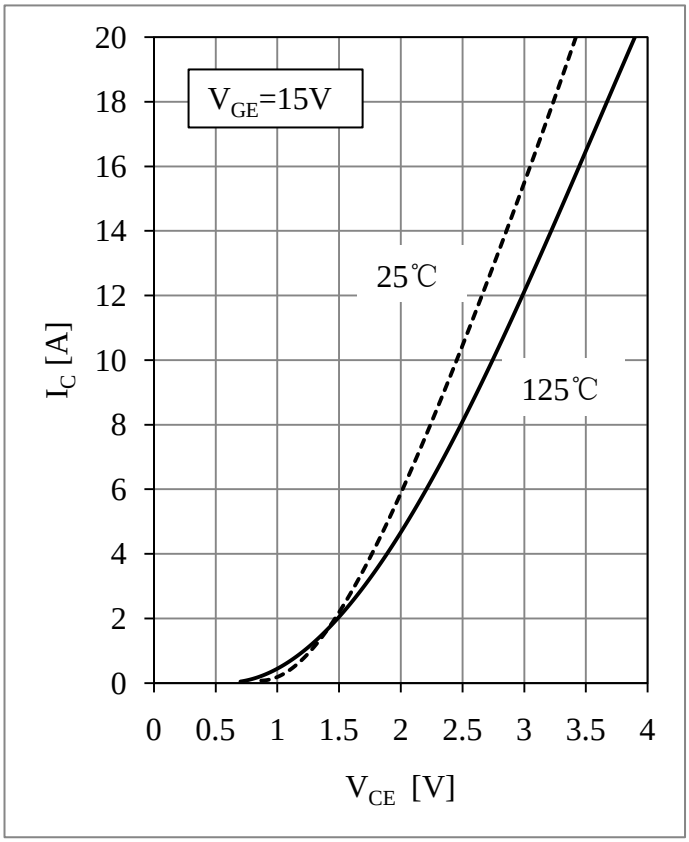


Fig 12. IGBT-brake-chopper Output Characteristics

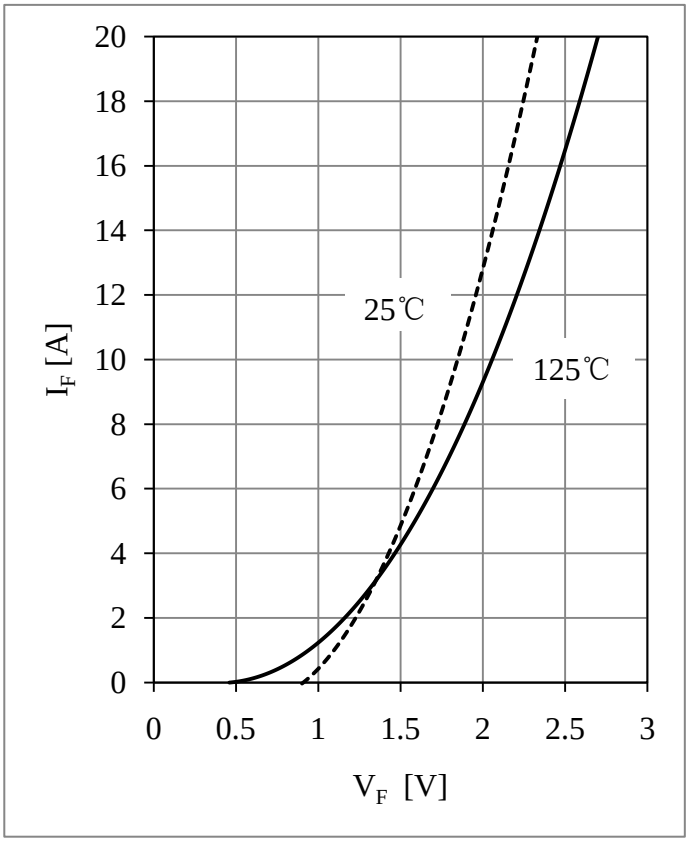


Fig 13. Diode-brake-chopper Forward Characteristic

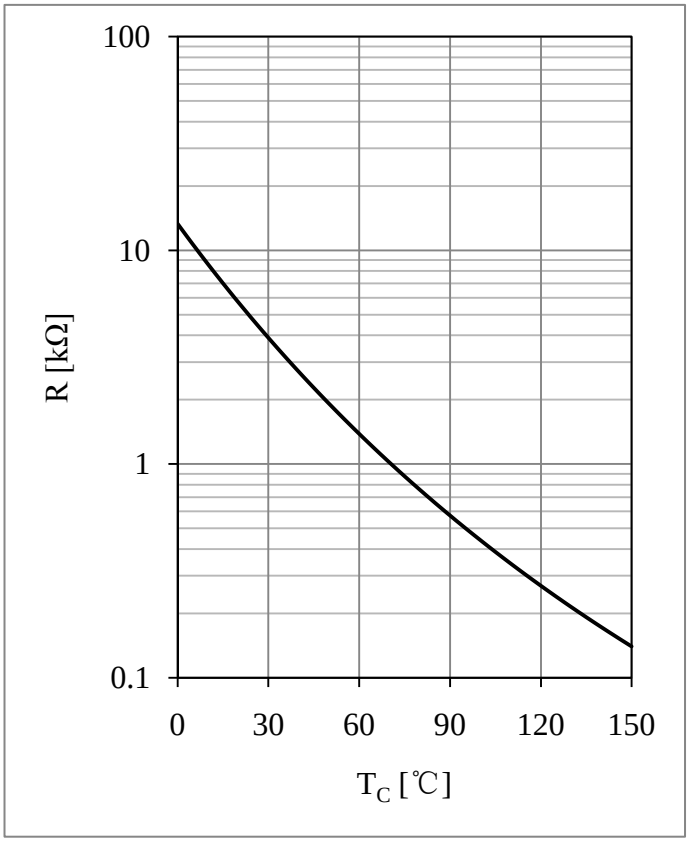
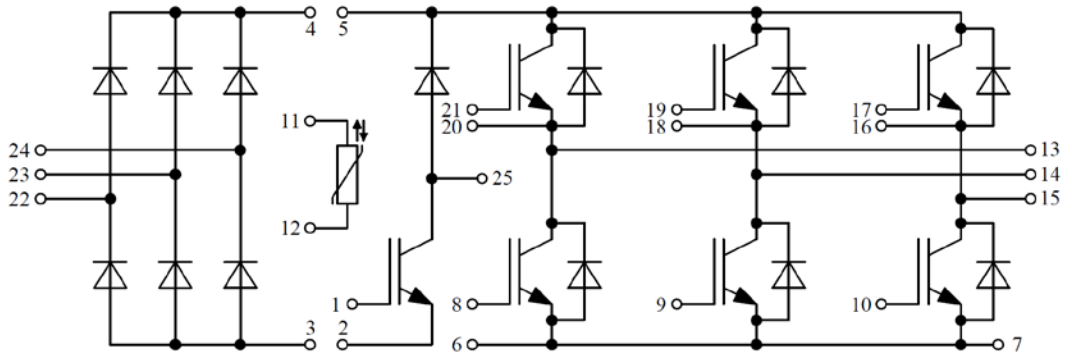


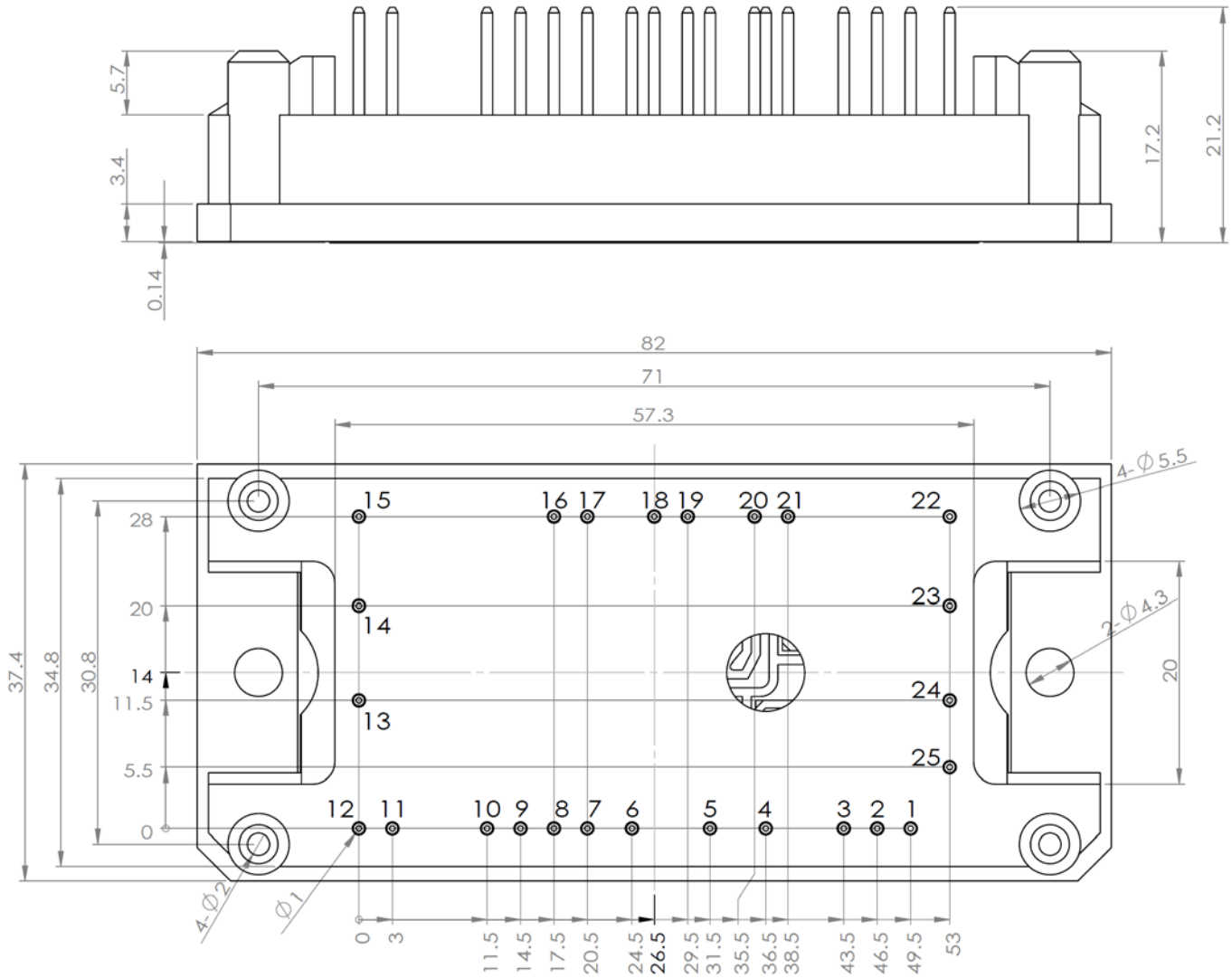
Fig 14. NTC Temperature Characteristic

Equivalent Circuit Schematic



Package Dimensions

Dimensions in Millimeters



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Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact the sales office, which is responsible for you.

Should you intend to use the Product in aviation applications, in health or live endangering or life support applications, please notify.

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